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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f874-04-l

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

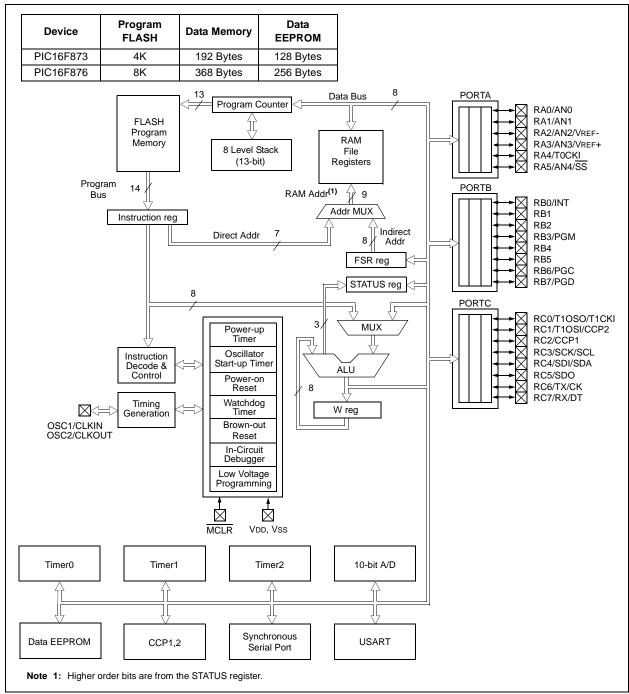
1.0 DEVICE OVERVIEW

This document contains device specific information. Additional information may be found in the PIC® MCU Mid-Range Reference Manual (DS33023), which may be obtained from your local Microchip Sales Representative or downloaded from the Microchip website. The Reference Manual should be considered a complementary document to this data sheet, and is highly recommended reading for a better understanding of the device architecture and operation of the peripheral modules.

There are four devices (PIC16F873, PIC16F874, PIC16F876 and PIC16F877) covered by this data sheet. The PIC16F876/873 devices come in 28-pin packages and the PIC16F877/874 devices come in 40-pin packages. The Parallel Slave Port is not implemented on the 28-pin devices.

The following device block diagrams are sorted by pin number; 28-pin for Figure 1-1 and 40-pin for Figure 1-2. The 28-pin and 40-pin pinouts are listed in Table 1-1 and Table 1-2, respectively.

FIGURE 1-1: PIC16F873 AND PIC16F876 BLOCK DIAGRAM



2.2 Data Memory Organization

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 (STATUS<6>) and RP0 (STATUS<5>) are the bank select bits.

RP1:RP0	Bank				
00	0				
01	1				
10	2				
11	3				

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain Special Function Registers. Some frequently used Special Function Registers from one bank may be mirrored in another bank for code reduction and quicker access.

Note:	EEPROM Data Memory description can be
	found in Section 4.0 of this data sheet.

2.2.1 GENERAL PURPOSE REGISTER FILE

The register file can be accessed either directly, or indirectly through the File Select Register (FSR).

2.2.2.3 INTCON Register

The INTCON Register is a readable and writable register, which contains various enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts.

Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON REGISTER (ADDRESS 0Bh, 8Bh, 10Bh, 18Bh)

bit 7		•					bit 0
GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF
R/W-0	R/W-x						

Note:

bit 7 GIE: Global Interrupt Enable bit

1 = Enables all unmasked interrupts

0 = Disables all interrupts

bit 6 **PEIE**: Peripheral Interrupt Enable bit

1 = Enables all unmasked peripheral interrupts

0 = Disables all peripheral interrupts

bit 5 **T0IE**: TMR0 Overflow Interrupt Enable bit

1 = Enables the TMR0 interrupt0 = Disables the TMR0 interrupt

bit 4 INTE: RB0/INT External Interrupt Enable bit

1 = Enables the RB0/INT external interrupt

0 = Disables the RB0/INT external interrupt

bit 3 RBIE: RB Port Change Interrupt Enable bit

1 = Enables the RB port change interrupt

0 = Disables the RB port change interrupt

bit 2 **T0IF**: TMR0 Overflow Interrupt Flag bit

1 = TMR0 register has overflowed (must be cleared in software)

0 = TMR0 register did not overflow

bit 1 INTF: RB0/INT External Interrupt Flag bit

1 = The RB0/INT external interrupt occurred (must be cleared in software)

0 = The RB0/INT external interrupt did not occur

bit 0 RBIF: RB Port Change Interrupt Flag bit

1 = At least one of the RB7:RB4 pins changed state; a mismatch condition will continue to set the bit. Reading PORTB will end the mismatch condition and allow the bit to be cleared (must be cleared in software).

0 = None of the RB7:RB4 pins have changed state

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

3.5 PORTE and TRISE Register

PORTE and TRISE are not implemented on the PIC16F873 or PIC16F876.

PORTE has three pins (RE0/RD/AN5, RE1/WR/AN6, and RE2/CS/AN7) which are individually configureable as inputs or outputs. These pins have Schmitt Trigger input buffers.

The PORTE pins become the I/O control inputs for the microprocessor port when bit PSPMODE (TRISE<4>) is set. In this mode, the user must make certain that the TRISE<2:0> bits are set, and that the pins are configured as digital inputs. Also ensure that ADCON1 is configured for digital I/O. In this mode, the input buffers are TTL.

Register 3-1 shows the TRISE register, which also controls the parallel slave port operation.

PORTE pins are multiplexed with analog inputs. When selected for analog input, these pins will read as '0's.

TRISE controls the direction of the RE pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

Note: On a Power-on Reset, these pins are configured as analog inputs, and read as '0'.

FIGURE 3-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)

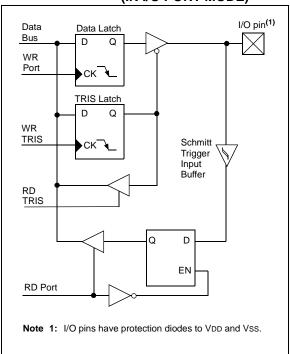


TABLE 3-9: PORTE FUNCTIONS

Name	Bit#	Buffer Type	Function
RE0/RD/AN5	bit0	ST/TTL ⁽¹⁾	 I/O port pin or read control input in Parallel Slave Port mode or analog input: RD 1 = Idle 0 = Read operation. Contents of PORTD register are output to PORTD I/O pins (if chip selected)
RE1/WR/AN6	bit1	ST/TTL ⁽¹⁾	 I/O port pin or write control input in Parallel Slave Port mode or analog input: WR 1 = Idle 0 = Write operation. Value of PORTD I/O pins is latched into PORTD register (if chip selected)
RE2/CS/AN7	bit2	ST/TTL ⁽¹⁾	I/O port pin or chip select control input in Parallel Slave Port mode or analog input: CS 1 = Device is not selected 0 = Device is selected

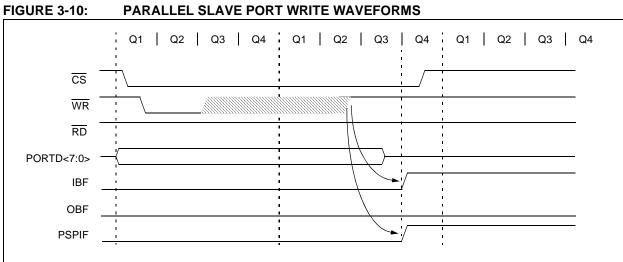
Legend: ST = Schmitt Trigger input, TTL = TTL input

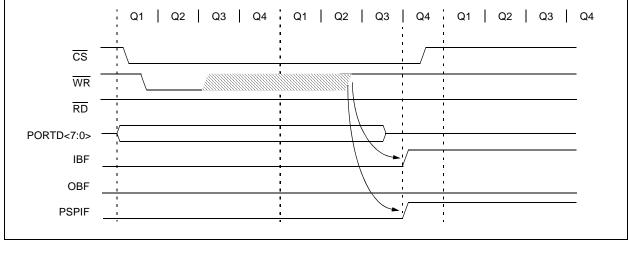
Note 1: Input buffers are Schmitt Triggers when in I/O mode and TTL buffers when in Parallel Slave Port mode.

TABLE 3-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
09h	PORTE	_		_	_	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE I	Data Direc	tion Bits	0000 -111	0000 -111
9Fh	ADCON1	ADFM	_	_	_	PCFG3	PCFG2	PCFG1	PCFG0	0- 0000	0- 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by PORTE.





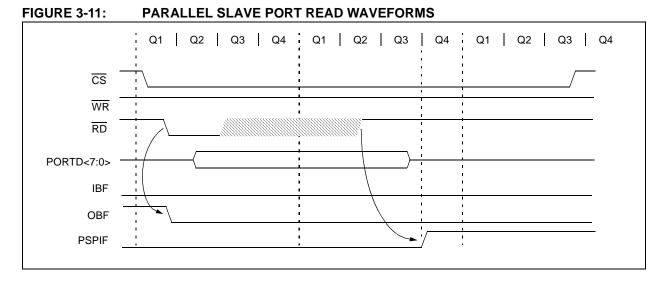


TABLE 3-11: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
08h	PORTD	Port Data Latch when written: Port pins when read								xxxx xxxx	uuuu uuuu
09h	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE D	ata Directi	on Bits	0000 -111	0000 -111
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
9Fh	ADCON1	ADFM		_	_	PCFG3	PCFG2	PCFG1	PCFG0	0- 0000	0- 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Parallel Slave Port. Note 1: Bits PSPIE and PSPIF are reserved on the PIC16F873/876; always maintain these bits clear.

4.9 FLASH Program Memory Write Protection

The configuration word contains a bit that write protects the FLASH program memory, called WRT. This bit can only be accessed when programming the PIC16F87X device via ICSP. Once write protection is enabled, only an erase of the entire device will disable it. When enabled, write protection prevents any writes to FLASH program memory. Write protection does not affect program memory reads.

TABLE 4-1: READ/WRITE STATE OF INTERNAL FLASH PROGRAM MEMORY

Cor	nfiguration	Bits	Moment Leastion	Internal	Internal	ICSP Read	ICSP Write
CP1	CP0	WRT	Memory Location	Read	Write	ICSP Read	ICSP Write
0	0	х	All program memory	Yes	No	No	No
0	1	0	Unprotected areas	Yes	No	Yes	No
0	1	0	Protected areas	Yes	No	No	No
0	1	1	Unprotected areas	Yes	Yes	Yes	No
0	1	1	Protected areas	Yes	No	No	No
1	0	0	Unprotected areas	Yes	No	Yes	No
1	0	0	Protected areas	Yes	No	No	No
1	0	1	Unprotected areas	Yes	Yes	Yes	No
1	0	1	Protected areas	Yes	No	No	No
1	1	0	All program memory	Yes	No	Yes	Yes
1	1	1	All program memory	Yes	Yes	Yes	Yes

TABLE 4-2: REGISTERS ASSOCIATED WITH DATA EEPROM/PROGRAM FLASH

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
10Dh	EEADR	EEPROM	EEPROM Address Register, Low Byte								uuuu uuuu
10Fh	EEADRH	_	— — EEPROM Address, High Byte							xxxx xxxx	uuuu uuuu
10Ch	EEDATA	EEPROM	EEPROM Data Register, Low Byte							xxxx xxxx	uuuu uuuu
10Eh	EEDATH	_	_	EEPROI	M Data Re	egister, Hig	h Byte			xxxx xxxx	uuuu uuuu
18Ch	EECON1	EEPGD	_	_	_	WRERR	WREN	WR	RD	x x000	x u000
18Dh	EECON2	EEPROM	EEPROM Control Register2 (not a physical register)							_	_
8Dh	PIE2	_	(1)	_	EEIE	BCLIE	_	_	CCP2IE	-r-0 00	-r-0 00
0Dh	PIR2	_	(1)	_	EEIF	BCLIF	_	_	CCP2IF	-r-0 00	-r-0 00

Legend: x = unknown, u = unchanged, r = reserved, - = unimplemented, read as '0'.

Shaded cells are not used during FLASH/EEPROM access.

Note 1: These bits are reserved; always maintain these bits clear.

TABLE 5-1: REGISTERS ASSOCIATED WITH TIMERO

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
01h,101h	TMR0	Timer0	Fimer0 Module's Register							xxxx xxxx	uuuu uuuu
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
81h,181h	OPTION_REG	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

REGISTER 9-3: SSPCON2: SYNC SERIAL PORT CONTROL REGISTER2 (ADDRESS 91h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

bit 7 GCEN: General Call Enable bit (In I²C Slave mode only)

1 = Enable interrupt when a general call address (0000h) is received in the SSPSR

0 = General call address disabled

bit 6 **ACKSTAT**: Acknowledge Status bit (In I²C Master mode only)

In Master Transmit mode:

1 = Acknowledge was not received from slave

0 = Acknowledge was received from slave

bit 5 **ACKDT**: Acknowledge Data bit (In I²C Master mode only)

In Master Receive mode:

Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.

1 = Not Acknowledge

0 = Acknowledge

bit 4 **ACKEN**: Acknowledge Sequence Enable bit (In I²C Master mode only)

In Master Receive mode:

1 = Initiate Acknowledge sequence on SDA and SCL pins and transmit ACKDT data bit. Automatically cleared by hardware.

0 = Acknowledge sequence idle

bit 3 RCEN: Receive Enable bit (In I²C Master mode only)

1 = Enables Receive mode for I^2C

0 = Receive idle

bit 2 **PEN**: STOP Condition Enable bit (In I²C Master mode only)

SCK Release Control:

1 = Initiate STOP condition on SDA and SCL pins. Automatically cleared by hardware.

0 = STOP condition idle

bit 1 **RSEN**: Repeated START Condition Enable bit (In I²C Master mode only)

1 = Initiate Repeated START condition on SDA and SCL pins. Automatically cleared by hardware.

0 = Repeated START condition idle

bit 0 **SEN**: START Condition Enable bit (In I²C Master mode only)

1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware.

0 = START condition idle

Note: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I²C module is not in the IDLE mode, this bit may not be set (no spooling), and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x =	= Bit is unknown

9.2.3 SLEEP OPERATION

While in SLEEP mode, the I²C module can receive addresses or data. When an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

9.2.4 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

TABLE 9-3: REGISTERS ASSOCIATED WITH I²C OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	V <u>alue o</u> n: MCLR, WDT
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Dh	PIR2	_	(2)	_	EEIF	BCLIF	_	_	CCP2IF	-r-0 00	-r-0 00
8Dh	PIE2	_	(2)	_	EEIE	BCLIE	_	_	CCP2IE	-r-0 00	-r-0 00
13h	SSPBUF	Synchrono	ynchronous Serial Port Receive Buffer/Transmit Register							xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
93h	SSPADD	I ² C Slave	² C Slave Address/Master Baud Rate Register						0000 0000	0000 0000	
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the SSP in I²C mode.

Note 1: These bits are reserved on PIC16F873/876 devices; always maintain these bits clear.

^{2:} These bits are reserved on these devices; always maintain these bits clear.

9.2.5 MASTER MODE

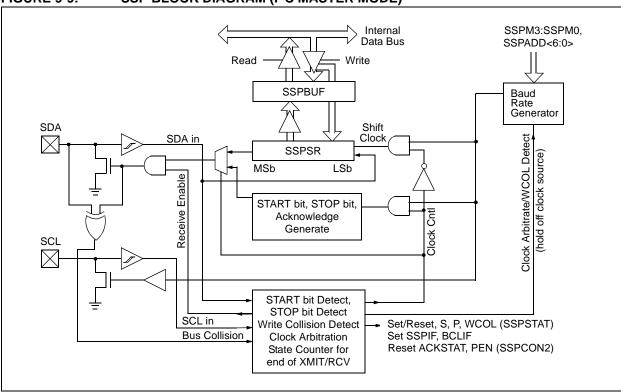
Master mode of operation is supported by interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a RESET, or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is idle, with both the S and P bits clear

In Master mode, the SCL and SDA lines are manipulated by the MSSP hardware.

The following events will cause the SSP Interrupt Flag bit, SSPIF, to be set (an SSP interrupt will occur if enabled):

- · START condition
- STOP condition
- Data transfer byte transmitted/received
- · Acknowledge transmit
- · Repeated START

FIGURE 9-9: SSP BLOCK DIAGRAM (I²C MASTER MODE)



9.2.6 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a RESET or when the MSSP module is disabled. Control of the I²C bus may be taken when bit P (SSPSTAT<4>) is set, or the bus is idle with both the S and P bits clear. When the bus is busy, enabling the SSP Interrupt will generate the interrupt when the STOP condition occurs.

In Multi-Master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware, with the result placed in the BCLIF bit.

The states where arbitration can be lost are:

- · Address Transfer
- · Data Transfer
- · A START Condition
- A Repeated START Condition
- · An Acknowledge Condition

9.2.12 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPCON2<3>).

Note: The SSP module must be in an IDLE state before the RCEN bit is set, or the RCEN bit will be disregarded.

The baud rate generator begins counting, and on each rollover, the state of the SCL pin changes (high to low/ low to high), and data is shifted into the SSPSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPSR are loaded into the SSPBUF, the BF flag is set, the SSPIF is set, and the baud rate generator is suspended from counting, holding SCL low. The SSP is now in IDLE state, awaiting the next command. When the buffer is read by the CPU, the BF flag is automatically cleared. The user can then send an Acknowledge bit at the end of reception, by setting the Acknowledge Sequence Enable bit, ACKEN (SSPCON2<4>).

9.2.12.1 BF Status Flag

In receive operation, BF is set when an address or data byte is loaded into SSPBUF from SSPSR. It is cleared when SSPBUF is read.

9.2.12.2 SSPOV Status Flag

In receive operation, SSPOV is set when 8 bits are received into the SSPSR, and the BF flag is already set from a previous reception.

9.2.12.3 WCOL Status Flag

If the user writes the SSPBUF when a receive is already in progress (i.e., SSPSR is still shifting in a data byte), then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

10.1 USART Baud Rate Generator (BRG)

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In Asynchronous mode, bit BRGH (TXSTA<2>) also controls the baud rate. In Synchronous mode, bit BRGH is ignored. Table 10-1 shows the formula for computation of the baud rate for different USART modes which only apply in Master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 10-1. From this, the error in baud rate can be determined.

It may be advantageous to use the high baud rate (BRGH = 1), even for slower baud clocks. This is because the Fosc/(16(X + 1)) equation can reduce the baud rate error in some cases.

Writing a new value to the SPBRG register causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

10.1.1 SAMPLING

The data on the RC7/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin.

TABLE 10-1: BAUD RATE FORMULA

	SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
Ī	0	(Asynchronous) Baud Rate = Fosc/(64(X+1))	Baud Rate = Fosc/(16(X+1))
	1	(Synchronous) Baud Rate = Fosc/(4(X+1))	N/A

X = value in SPBRG (0 to 255)

TABLE 10-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
99h	SPBRG	Baud Rate Generator Register						0000 0000	0000 0000		

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used by the BRG.

PIC16F87X

NOTES:

11.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 11-2. The source impedance (Rs) and the internal sampling switch (RsS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RsS) impedance varies over the device voltage (VDD), see Figure 11-2. The maximum recommended impedance for analog sources is $10~\mathrm{k}\Omega$. As the impedance is decreased, the acquisition time may be decreased.

After the analog input channel is selected (changed), this acquisition must be done before the conversion can be started.

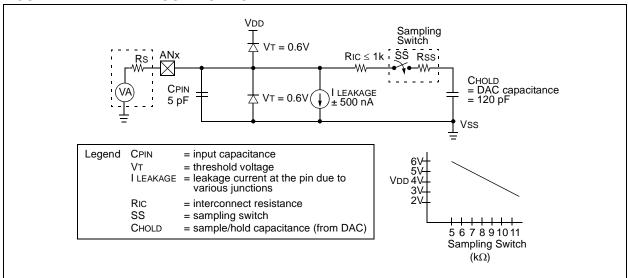
To calculate the minimum acquisition time, Equation 11-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

To calculate the minimum acquisition time, TACQ, see the PIC® MCU Mid-Range Reference Manual (DS33023).

EQUATION 11-1: ACQUISITION TIME

- Note 1: The reference voltage (VREF) has no effect on the equation, since it cancels itself out.
 - 2: The charge holding capacitor (CHOLD) is not discharged after each conversion.
 - **3:** The maximum recommended impedance for analog sources is 10 kΩ. This is required to meet the pin leakage specification.
 - **4:** After a conversion has completed, a 2.0TAD delay must complete before acquisition can begin again. During this time, the holding capacitor is not connected to the selected A/D input channel.

FIGURE 11-2: ANALOG INPUT MODEL



15.2 DC Characteristics: PIC16F873/874/876/877-04 (Commercial, Industrial) PIC16F873/874/876/877-20 (Commercial, Industrial) PIC16LF873/874/876/877-04 (Commercial, Industrial)

DC CHA	RACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C}$ for commercial Operating voltage VDD range as described in DC specification (Section 15.1)							
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions			
	VIL	Input Low Voltage								
		I/O ports								
D030		with TTL buffer	Vss	_	0.15VDD	V	For entire VDD range			
D030A			Vss	_	0.8V	V	$4.5V \le VDD \le 5.5V$			
D031		with Schmitt Trigger buffer	Vss	_	0.2Vdd	V				
D032		MCLR, OSC1 (in RC mode)	Vss	_	0.2Vdd	V				
D033		OSC1 (in XT, HS and LP)	Vss	_	0.3VDD	V	(Note 1)			
		Ports RC3 and RC4		_						
D034		with Schmitt Trigger buffer	Vss	_	0.3VDD	V	For entire VDD range			
D034A		with SMBus	-0.5	_	0.6	V	for VDD = 4.5 to 5.5V			
	VIH	Input High Voltage			•	•				
		I/O ports		_						
D040		with TTL buffer	2.0	_	Vdd	V	$4.5V \le VDD \le 5.5V$			
D040A			0.25VDD + 0.8V	_	VDD	V	For entire VDD range			
D041		with Schmitt Trigger buffer	0.8VDD	_	Vdd	V	For entire VDD range			
D042		MCLR	0.8VDD	_	Vdd	V				
D042A		OSC1 (XT, HS and LP)	0.7Vdd	_	Vdd	V	(Note 1)			
D043		OSC1 (in RC mode) Ports RC3 and RC4	0.9Vdd	_	VDD	V				
D044		with Schmitt Trigger buffer	0.7Vdd	_	Vdd	V	For entire VDD range			
D044A		with SMBus	1.4	_	5.5	V	for VDD = 4.5 to 5.5V			
D070	IPURB	PORTB Weak Pull-up Current	50	250	400	μА	VDD = 5V, VPIN = VSS, -40°C TO +85°C			
	lıL	Input Leakage Current ^(2, 3)			•					
D060		I/O ports	_	_	±1	μА	Vss ≤ VPIN ≤ VDD, Pin at hi-impedance			
D061		MCLR, RA4/T0CKI	_	_	±5	μА	Vss ≤ Vpin ≤ Vdd			
D063		OSC1	_	_	±5	μΑ	Vss ≤ VPIN ≤ VDD, XT, HS and LP osc configuration			

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F87X be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

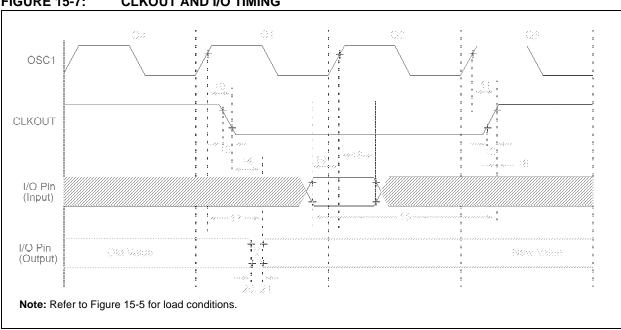


FIGURE 15-7: CLKOUT AND I/O TIMING

TABLE 15-2: CLKOUT AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Charac	Min	Тур†	Max	Units	Conditions	
10*	TosH2ckL	OSC1↑ to CLKOUT↓	_	75	200	ns	(Note 1)	
11*	TosH2ck H	OSC1↑ to CLKOUT↑	_	75	200	ns	(Note 1)	
12*	TckR	CLKOUT rise time		_	35	100	ns	(Note 1)
13*	TckF	CLKOUT fall time		_	35	100	ns	(Note 1)
14*	TckL2ioV	CLKOUT ↓ to Port out val	_	_	0.5Tcy + 20	ns	(Note 1)	
15*	TioV2ckH	Port in valid before CLKO	Tosc + 200	_	_	ns	(Note 1)	
16*	TckH2iol	Port in hold after CLKOUT	0	_	_	ns	(Note 1)	
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid		_	100	255	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to	Standard (F)	100	_	_	ns	
		Port input invalid (I/O in hold time)	Extended (LF)	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC11	(I/O in setup time)	0	_	_	ns	
20*	TioR	Port output rise time	Standard (F)	_	10	40	ns	
			Extended (LF)	_	_	145	ns	
21*	TioF	Port output fall time	Standard (F)	_	10	40	ns	
			Extended (LF)	_	_	145	ns	
22††*	Tinp	INT pin high or low time		Tcy	_	_	ns	
23††*	Trbp	RB7:RB4 change INT high	Tcy	_	_	ns		

These parameters are characterized but not tested.

Note 1: Measurements are taken in RC mode where CLKOUT output is 4 x Tosc.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are

^{††} These parameters are asynchronous events not related to any internal clock edges.

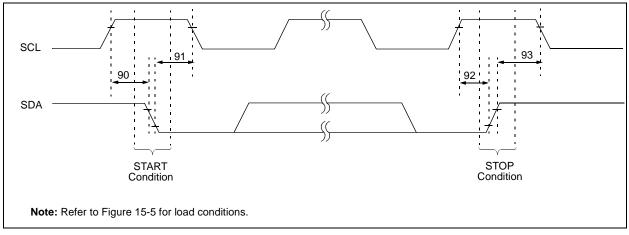
PIC16F87X

TABLE 15-7: SPI MODE REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions	
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Тсу	_	_	ns		
71*	TscH	SCK input high time (Slave mode)		Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (Slave mode)		Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK	100	_	_	ns		
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	_	_	ns	
75*	TdoR	SDO data output rise time	Standard(F) Extended(LF)	_	10 25	25 50	ns ns	
76*	TdoF	SDO data output fall time		_	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance		10	_	50	ns	
78*	TscR	SCK output rise time (Master mode) Standard(F) Extended(LF)			10 25	25 50	ns ns	
79*	TscF	SCK output fall time (Master mode)		_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	Standard(F) Extended(LF)		_	50 145	ns	
81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge		Tcy	_	_	ns	
82*	TssL2doV	SDO data output valid after SS ↓ edge		_	_	50	ns	
83*	TscH2ssH, TscL2ssH	1 .		1.5Tcy + 40	_	_	ns	

^{*} These parameters are characterized but not tested.

FIGURE 15-17: I²C BUS START/STOP BITS TIMING



[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

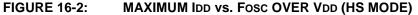
16.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

The graphs and tables provided in this section are for design guidance and are not tested.

In some graphs or tables, the data presented is **outside specified operating range** (i.e., outside specified VDD range). This is for **information only** and devices are ensured to operate properly only within the specified range.

The data presented in this section is a **statistical summary** of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at 25° C. 'max' or 'min' represents (mean + 3σ) or (mean - 3σ) respectively, where σ is standard deviation, over the whole temperature range.

FIGURE 16-1: TYPICAL IDD vs. Fosc OVER VDD (HS MODE) Typical: statistical mean @ 25°C Maximum: mean + 3s (-40°C to 125°C) Minimum: mean - 3s (-40°C to 125°C) lop (mA) 4 0 V 3.5V 3.0V 2.5V 6 10 12 14 16 18 20 Fosc (MHz)



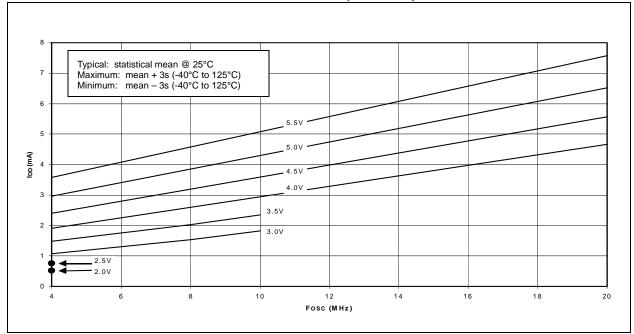


FIGURE 16-9: AVERAGE FOSC vs. VDD FOR VARIOUS VALUES OF R (RC MODE, C = 300 pF, 25°C)

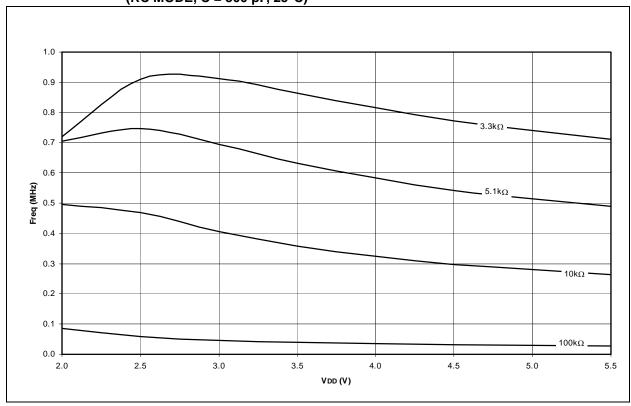
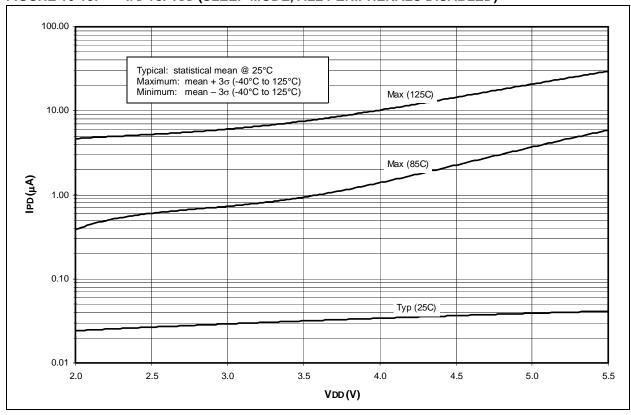


FIGURE 16-10: IPD vs. VDD (SLEEP MODE, ALL PERIPHERALS DISABLED)



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W

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